

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior version and listing of claims in the present application. Please amend claims 1 and 11.

1. (Currently amended) A laminate for IR ablation comprising at least a substrate and an IR ablation layer, wherein the aforementioned IR ablation layer is a layer consisting of an IR absorbent metal layer.
2. (Original) The laminate for IR ablation of claim 1, wherein the IR absorbent metal layer is a metal deposition layer.
3. (Original) The laminate for IR ablation of claim 1, which further comprises an anti-blocking layer on the opposite side of the IR ablation layer of the substrate.
4. (Original) The laminate for IR ablation of claim 1, which further comprises a release layer between the substrate and the IR ablation layer.
5. (Original) The laminate for IR ablation of claim 3, wherein the anti-blocking layer comprises a thermosetting resin.
6. (Original) The laminate for IR ablation of claim 3, wherein the anti-blocking layer comprises an alkyd resin.
7. (Original) The laminate for IR ablation of claim 4, wherein the release layer comprises a thermosetting resin.
8. (Original) The laminate for IR ablation of claim 4, wherein the release layer comprises an alkyd resin.
9. (Original) The laminate for IR ablation of claim 1, which further comprises an IR non-sensitive polymer resin layer between the substrate and the IR absorbent metal layer.

10. (Original) The laminate for IR ablation of claim 4, which further comprises an IR non-sensitive polymer resin layer between the release layer and the IR absorbent metal layer.
11. (Currently amended) A method for forming a mask on a photosensitive resin layer, which comprises a step of IR ablation of a laminate comprising at least a substrate and an IR ablation layer which is laminated on said photosensitive resin layer, wherein the IR ablation layer is a layer consisting of an IR absorbent metal layer.
12. (Original) The method of claim 11, wherein the IR absorbent metal layer is a metal deposition layer.
13. (Original) The method of claim 11, wherein the laminate comprises an anti-blocking layer on the opposite side of an IR ablation layer of the substrate.
14. (Original) The method of claim 11, wherein the laminate comprises a release layer between the substrate and the IR ablation layer.
15. (Original) The method of claim 13, wherein the anti-blocking layer comprises a thermosetting resin.
16. (Original) The method of claim 13, wherein the anti-blocking layer comprises an alkyd resin.
17. (Original) The method of claim 14, wherein the release layer comprises a thermosetting resin.
18. (Original) The method of claim 14, wherein the release layer comprises an alkyd resin.
19. (Original) The method of claim 11, wherein the laminate comprises an IR non-sensitive polymer resin layer between the substrate and the IR absorbent metal layer.

20. (Original) The method of claim 14, wherein the laminate comprises an IR non-sensitive polymer resin layer between the release layer and the IR absorbent metal layer.